

## Calibration and Monitoring



Sebastian Schätzel Felix Sefkow

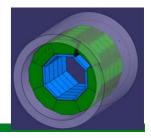




Sep 13, 2007



## R&D review panel:



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### (draft)

- "The future test beam program will and needs to assess the impact of long term stability, failure rate, aging and monitoring (timedependence, LED monitoring) issues.
- Also the mip and calibration procedures in major systems need to be understood.

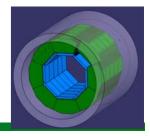
### (...)

The inclusion of calibration data methods, i.e. mips and test pulses, is also important in understanding what data is needed to maintain the performance of these high granularity calorimeters in an experiment."





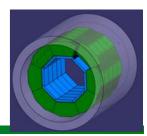
## To be done:



- Work out ILC performance requirements
- Develop a concept for ILC calorimeter calibration
- Calibrate the test beam prototype
- Understand its performance limitations
- In parallel: develop technological options





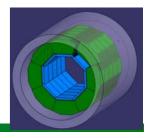


- $\sigma_E^{had} / E = stoch. / JE \oplus const \oplus noise / E$
- $\sigma_{jet} = \sigma (\sigma_{E}^{had}, noise, cluster recognition,....)$
- The performance requirements are not yet finalized
- Little has been said so far on the requirements for
  - the constant term (high energy limit): calibration!
  - noise term (low energy limit)
  - dynamic range
  - The terms depend on completely different features of the detector technology
- Detector performance studies (benchmarks) with detector effects included - to assess sensitivity to parameters





## Calibration concept



- MIP calibration: regular, but not instantaneous: long-term
- Monitoring (LED, gain, temperatures): short term variations
- MIP calibration at the ILC
  - Deep site, power pulsing, detector not rotating 

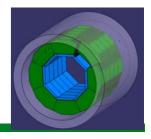
     cannot (fully) rely on cosmics
  - Imaging calorimeter has MIP segments in "every" hadron shower
  - Does it work??
    - Can we find them? Deep analysis starting point
    - Efficiency vs accuracy trade-off
    - Systematics: purity, track angle effects,...
    - Validate with test beam data
    - Estimate realistic rates at the ILC
  - Determine the time intervals to be bridged by monitoring system



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## Monitoring concepts



- Correct for (mostly) temperature-induced short-term variations using
  - Temperature sensors
  - SiPM gain ("auto-calibration")
  - LED reference pulses
- The first 2 methods need coefficients from the test bench
  - Gain, 1/G dG/dV, total response 1/A dA/dV
  - Temperature affects breakdown voltage:  $dx/dT = dx/dV * dV_0/dT$
  - $dV_0/dT$  quite uniform: 0.057(8) V / K
  - Expected to cancel in ratio: (dG/dT) / (dA/dT); check!
- Test beam analysis (theory)
  - Get corrections (and errors)
  - Cross-check
  - Validate with fortunately frequent MIP calibrations

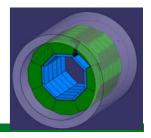


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## Monitoring in practice



- Treatment of data much more involved than we thought
- Temperature data suffer from finite granularity and offsets
  - Use physics-motivated profiles for smoothing ( $\rightarrow$  V.Morgunov)
- LED data require PIN monitoring which suffer from
  - High amplitude large non-linearity corrections
  - Pedestal instabilities
  - Only low statistics, but can test the concept
- Gain data: major data processing effort (grid), inefficiencies (2006)
- MIP data
  - Incomplete (also a big effort)
  - Still systematic and reproducibility problems to be understood



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# Correction of HCAL temperature dependence

S. Schätzel

23 August 2007

#### a writeup will be released next week

#### done

CALICE Scintillator HCAL Temperature Dependence and Correction Methods using LEDs

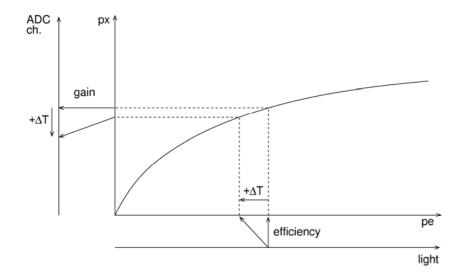
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> > August 22, 2007

#### Abstract

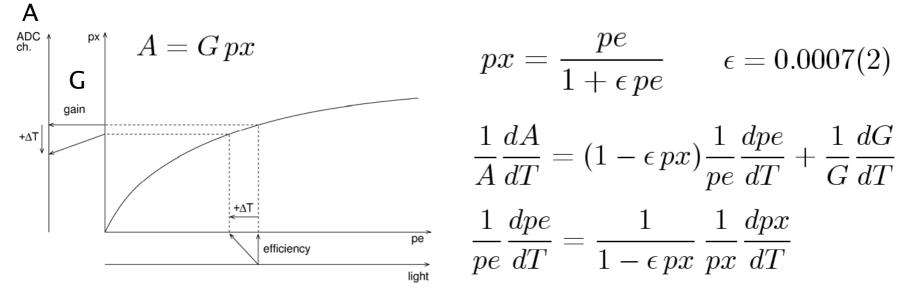
The CALICE Collaboration has built a prototype of a scintillator/steel sandwich hadronic calorimeter with novel silicon photosensors (SiPMs) to read out the scintillation light. The response of the photosensors is sensitive to temperature variations and a light injection system with LEDs was installed to study the dependence and correct for it. This article presents measurements of the temperature dependence and correction methods.

### **T** dependence and correction strategy



#### SiPM less sensitive to $\Delta T$ at high amplitudes

### **T** dependence and correction strategy



SiPM less sensitive to  $\Delta T$  at high amplitudes

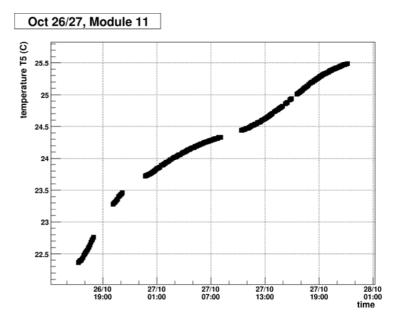
1. measure 
$$\frac{1}{pe} \frac{dpe}{dT}$$
 at LED monitoring point  
2. calculate correction factor at arbitrary amplitude

### Data sample

#### October 26-27, 2006 20 Modules with T read-out ΔT artificially enhanced to +3K by removing cooling fans

#### Sensor $\rightarrow$ SiPM assignment

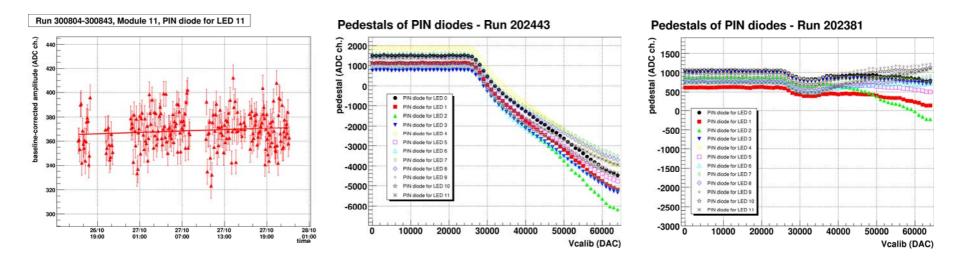
ASIC chip	temperature sensor	
0	T1	
1-3	Т2	
4-7	Τ3	
8-10	Τ4	
11	Τ5	



### **Selection of stable LEDs**

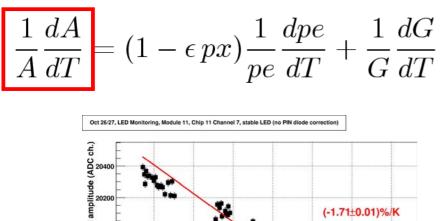
normalisation of PIN diode amplitude is unknown (V<sub>calib</sub> dependent, so far shift is not measured reproducibly)

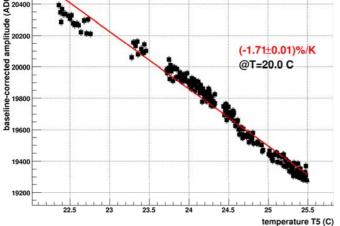
use PIN diodes as a veto against LED fluctuations



5 LEDs of 240 (2%) in 20 modules classified as stable

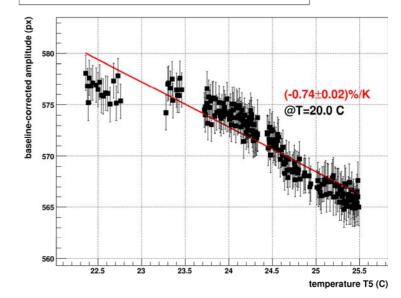
### **T** dependence of amplitude





 $\frac{1}{pe}\frac{dpe}{dT} = \frac{1}{1-\epsilon px}\frac{1}{px}\frac{dpx}{dT}$ 1 dpx

Oct 26/27, LED Monitoring, Module 11, Chip 11 Channel 7, stable LED (no PIN diode correction)



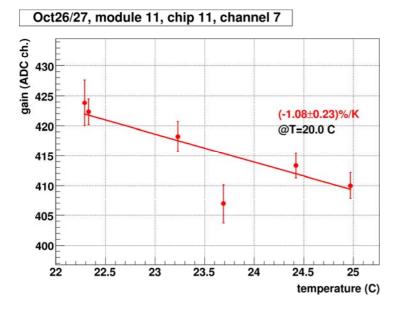
using G(T) in DB

## (PIN diode not sensitive enough to resolve normalisation changes)

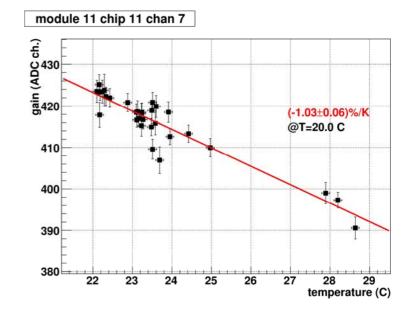
# **T dependence of Gai** $\frac{1}{A}\frac{dA}{dT} = (1 - \epsilon px)\frac{1}{pe}\frac{dpe}{dT} + \frac{1}{G}\frac{dG}{dT}$

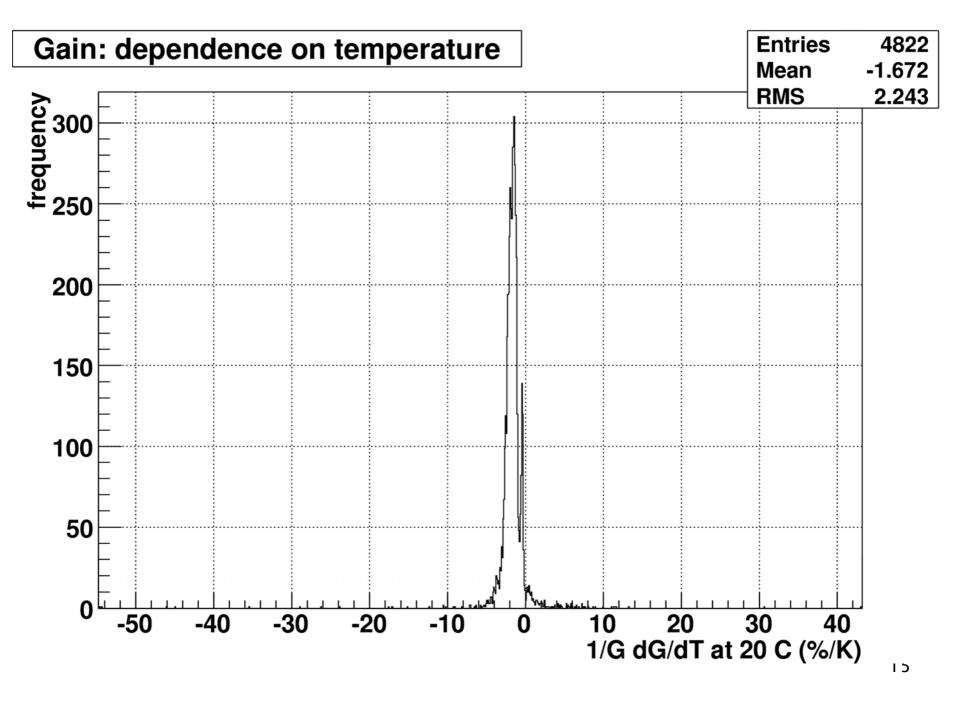
gain fits by Beni ROOT analysis by Sebastian Schmidt SiPM gains at bias voltage U<sub>0</sub>+0.6V

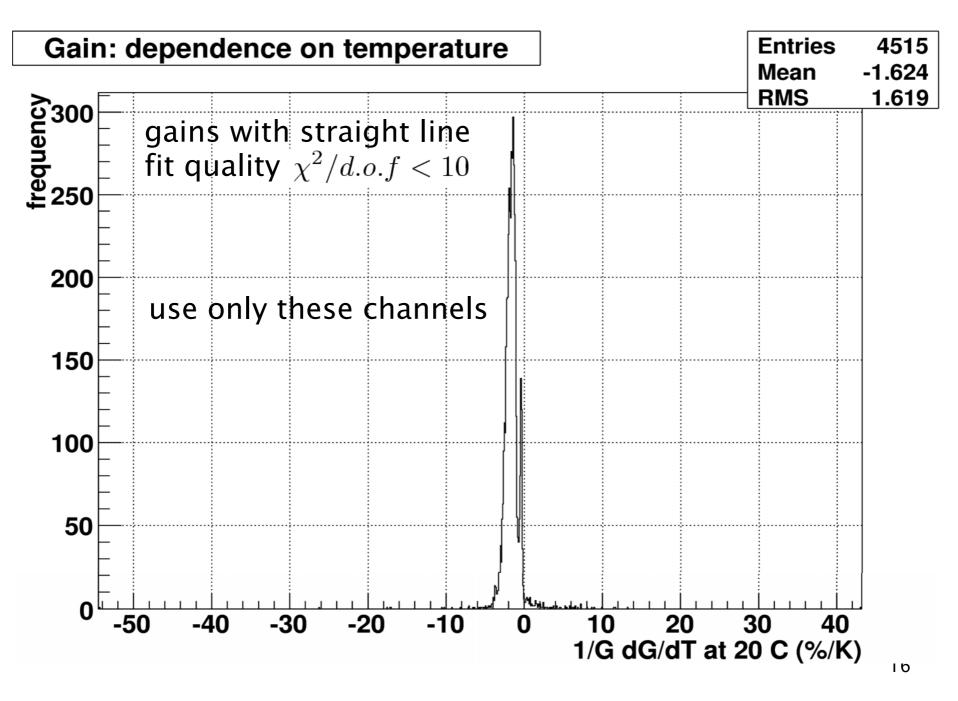
Only Oct. 26/27



#### Full 2006 gain sample



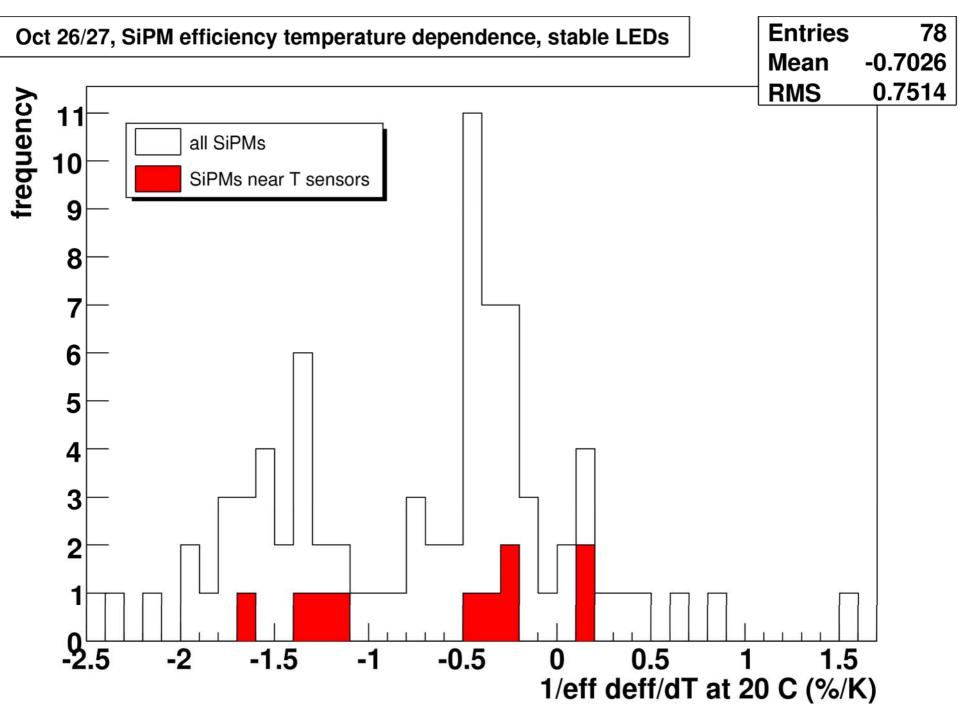




### **T** dependence of efficiency

$\frac{1}{pe}\frac{dp}{dz}$		$\frac{1}{-\epsilon px} \frac{1}{px} \frac{dp}{dx}$	$\frac{\partial x}{T}$ $\frac{1}{A}\frac{dA}{dT} = (1 - 1)$	$(\epsilon px) \frac{1}{pe} \frac{dpe}{dT} + \frac{1}{G} \frac{dG}{dT}$
Module	Chip	Channel	$\blacktriangleright \frac{1}{pe} \frac{dpe}{dT}$ (from pixels)	$\frac{1}{pe}\frac{dpe}{dT}$ (from slopes)
11	11	7	-1.3(3)%/K	-1.2(3)%/K
11	11	8	-1.5(2)%/K	-1.3(2)%/K
11	11	15	-1.6(1)%/K	-1.5(2)%/K

agreement within uncertainties both methods use the same information  $\rightarrow$  consistency checked

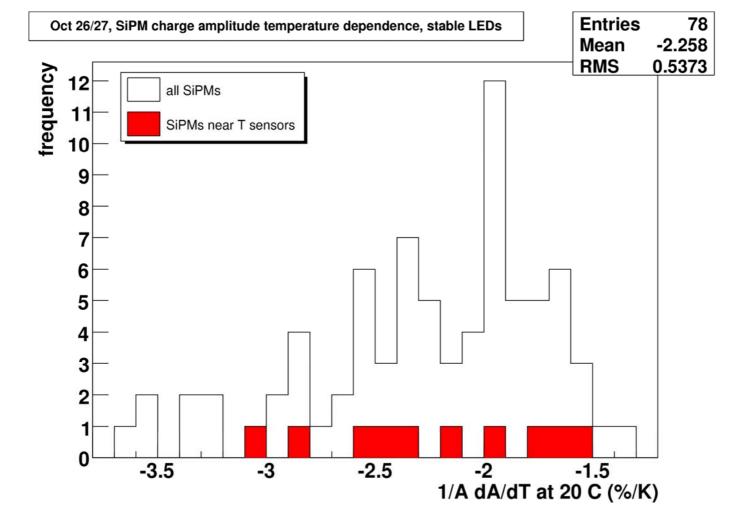


## Charge amplitude T dependence at 1 15(1) $\frac{1}{A}\frac{dA}{dT} = (1 - \epsilon px)\frac{1}{pe}\frac{dpe}{dT} + \frac{1}{G}\frac{dG}{dT}$

Module	Chip	Channel	$\frac{1}{A}\frac{dA}{dT}(15 \ px)$	$\frac{1}{A}\frac{dA}{dT}(LED)$
11	11	7	-2.3(3)%/K	-1.71(1)%/K
11	11	8	-2.5(2)%/K	-2.14(1)%/K
11	11	15	-2.8(2)%/K	-2.43(2)%/K

### to do: comparison with Moscow coefficients

(which tend to be higher)



Correction factor for physics analysis:

$$A(T) = A(T_0) \left( 1 + \Delta T \frac{1}{A(T_0)} \left. \frac{dA}{dT} \right|_{T_0} \right)$$

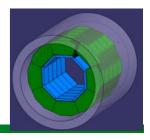
### Summary

- a procedure to correct the HCAL temperature dependence was presented
- gain, efficiency and amplitude T dependence was measured
- amplitude T dependence depends on amplitude
- only <2% of channels measured so far
  - rest has unstable LED
  - PIN diode correction needs knowledge of PIN pedestal
    - vs.  $V_{calib}$
- Next:
  - application to MIP
  - comparison with Moscow measurements
  - a writeup will be available

Study MIP at different bias-V



## Understand performance

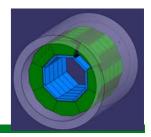


- We need to understand quantitatively the impact of calibration uncertainties on the performance
  - To guide and focus our efforts
  - To provide feedback to detector developers
- Implement detector effects in simulation / digitisation
  - Noise
  - SiPM non-linearity
  - Calibration uncertainty
    - MIP, gain, response function systematics
    - Incoherent (random), coherent (temperature effects)
- Reproduce observed resolution
  - As function of energy: impact on stochastic, noise, constant terms
- Study sensitivity to potential improvements or simplifications





## Technological options



- Optical signal distribution
  - central pulser and light source (one or few per layer)
  - Minimized cross-talk to readout (photo-sensors and FEE)
  - Monitoring of light source possible

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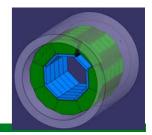
- Most frequently made choice, experience
- Electrical signal distribution
  - Many pulsers and LEDs, one per single or few channels
  - Avoids optical coupling problems (stability, uniformity)
  - Can work with very small electrical and optical pulses
  - Not yet tried
- NB: nobody\* works on optical signal distribution so far



\* HCAL



## Summary: projects



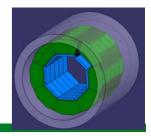
- Calibration concept:
  - MIPs from hadron showers, test beam and ILC
- Monitoring concept:
  - Develop and validate temperature corrections
- Understand performance:
  - Model the data and guide the optimization
- Technologies:
  - Develop light injection system for large scale application



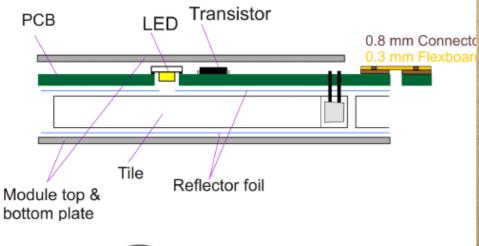
Backup slides



## LED test board

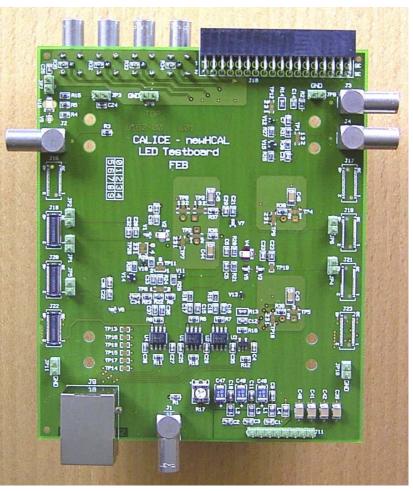


- Proof-of-principle, check for cross-talk, uniformity, heat
- Test also
  - Different driver schematics
  - Small connector
  - SiPM coupling





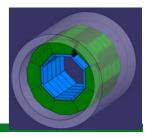
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- Define procedures
  - and stick to them even if they are not perfect yet
- Make tools available in a form such that we can ask old and new collaborators for help
- Define validity ranges
- Make results available in a central place
  - data base, n-tuple, flat file,...
  - such that we can study correlations
- Conceptual studies focus on 2006 while 2007 clean-up goes on
  - Assess accuracies, maybe GOTO 1



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